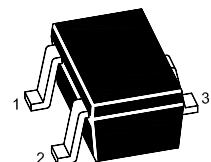
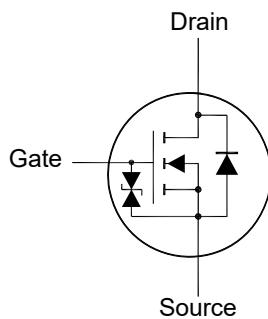


# MKB03N093LK-HAF

## N-Channel Enhancement Mode MOSFET

### Features

- ESD protected
- Surface-mounted package
- Halogen and Antimony Free(HAF), RoHS compliant



1. Gate 2. Source 3. Drain  
SOT-323 Plastic Package

### Applications

- Portable appliances
- Battery management

### Absolute Maximum Ratings (at $T_a = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 12$	V
Drain Current	$I_D$	2	A
Peak Drain Current <sup>1)</sup>	$I_{DM}$	4	A
Power Dissipation <sup>2)</sup>	$P_D$	400	mW
Operating Junction and Storage Temperature Range	$T_J, T_{stg}$	- 55 to + 150	°C

### Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient <sup>2)</sup>	$R_{\theta JA}$	312	°C/W

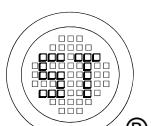
<sup>1)</sup> Pulse Test: Pulse Width  $\leq 100 \mu\text{s}$ , Duty Cycle  $\leq 2\%$ , Repetitive rating, pulse width limited by junction temperature  $T_{J(MAX)}$ .

<sup>2)</sup> Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air.

# MKB03N093LK-HAF

Characteristics at  $T_a = 25^\circ\text{C}$  unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>					
Drain-Source Breakdown Voltage at $I_D = 250 \mu\text{A}$	$\text{BV}_{\text{DSS}}$	30	-	-	V
Drain-Source Leakage Current at $V_{\text{DS}} = 30 \text{ V}$	$I_{\text{DSS}}$	-	-	1	$\mu\text{A}$
Gate Leakage Current at $V_{\text{GS}} = \pm 12 \text{ V}$	$I_{\text{GSS}}$	-	-	$\pm 10$	$\mu\text{A}$
Gate-Source Threshold Voltage at $V_{\text{DS}} = V_{\text{GS}}$ , $I_D = 250 \mu\text{A}$	$V_{\text{GS}(\text{th})}$	0.5	-	1.1	V
Drain-Source On-State Resistance at $V_{\text{GS}} = 4.5 \text{ V}$ , $I_D = 2 \text{ A}$ at $V_{\text{GS}} = 2.5 \text{ V}$ , $I_D = 1 \text{ A}$	$R_{\text{DS}(\text{on})}$	-	-	93 115	$\text{m}\Omega$
<b>DYNAMIC PARAMETERS</b>					
Gate Resistance at $V_{\text{GS}} = 0 \text{ V}$ , $V_{\text{DS}} = 0 \text{ V}$ , $f = 1 \text{ MHz}$	$R_g$	-	1.5	-	$\text{k}\Omega$
Input Capacitance at $V_{\text{GS}} = 0 \text{ V}$ , $V_{\text{DS}} = 15 \text{ V}$ , $f = 1 \text{ MHz}$	$C_{\text{iss}}$	-	387	-	pF
Output Capacitance at $V_{\text{GS}} = 0 \text{ V}$ , $V_{\text{DS}} = 15 \text{ V}$ , $f = 1 \text{ MHz}$	$C_{\text{oss}}$	-	37	-	pF
Reverse Transfer Capacitance at $V_{\text{GS}} = 0 \text{ V}$ , $V_{\text{DS}} = 15 \text{ V}$ , $f = 1 \text{ MHz}$	$C_{\text{rss}}$	-	10	-	pF
Total Gate Charge at $V_{\text{GS}} = 10 \text{ V}$ , $V_{\text{DS}} = 15 \text{ V}$ , $I_D = 2 \text{ A}$	$Q_g$	-	14	-	nC
Gate-Source Charge at $V_{\text{GS}} = 10 \text{ V}$ , $V_{\text{DS}} = 15 \text{ V}$ , $I_D = 2 \text{ A}$	$Q_{\text{gs}}$	-	1.2	-	nC
Gate-Drain Charge at $V_{\text{GS}} = 10 \text{ V}$ , $V_{\text{DS}} = 15 \text{ V}$ , $I_D = 2 \text{ A}$	$Q_{\text{gd}}$	-	2.6	-	nC
Turn-On Delay Time at $V_{\text{DD}} = 15 \text{ V}$ , $V_{\text{GS}} = 10 \text{ V}$ , $I_D = 1 \text{ A}$ , $R_g = 1 \Omega$	$t_{\text{d}(\text{on})}$	-	1138	-	nS
Turn-On Rise Time at $V_{\text{DD}} = 15 \text{ V}$ , $V_{\text{GS}} = 10 \text{ V}$ , $I_D = 1 \text{ A}$ , $R_g = 1 \Omega$	$t_r$	-	68	-	nS
Turn-Off Delay Time at $V_{\text{DD}} = 15 \text{ V}$ , $V_{\text{GS}} = 10 \text{ V}$ , $I_D = 1 \text{ A}$ , $R_g = 1 \Omega$	$t_{\text{d}(\text{off})}$	-	892	-	nS
Turn-Off Fall Time at $V_{\text{DD}} = 15 \text{ V}$ , $V_{\text{GS}} = 10 \text{ V}$ , $I_D = 1 \text{ A}$ , $R_g = 1 \Omega$	$t_f$	-	98	-	nS
<b>Body-Diode PARAMETERS</b>					
Diode Forward Voltage at $I_s = 1 \text{ A}$ , $V_{\text{GS}} = 0 \text{ V}$	$V_{\text{SD}}$	-	-	1.2	V
Body-Diode Continuous Current	$I_s$	-	-	2	A



Preliminary

Dated: 27/04/2021 P1

# MKB03N093LK-HAF

## Electrical Characteristics Curves

Fig. 1 Typical Output Characteristic

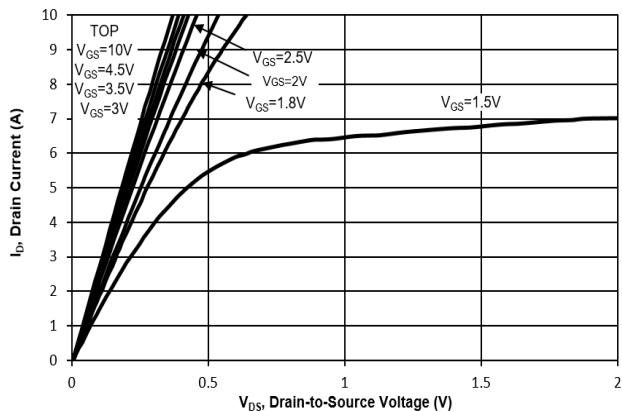


Fig. 2 Typical Transfer Characteristic

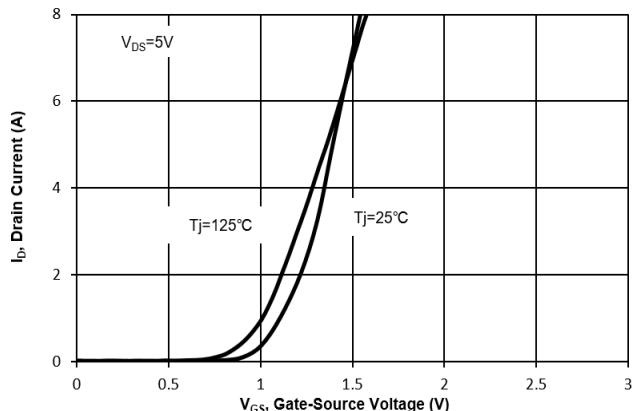


Fig. 3 on-Resistance vs. Drain Current

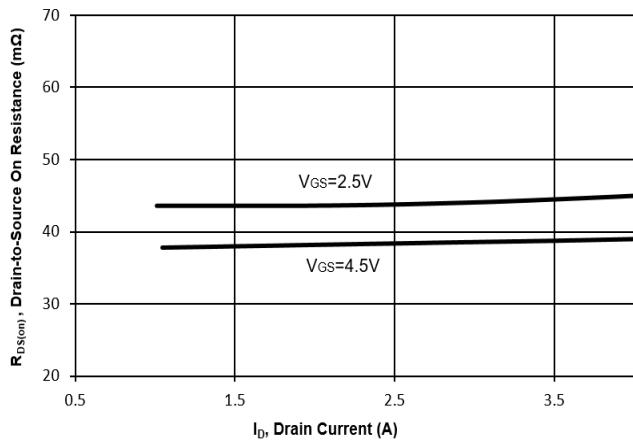


Fig. 4 on-Resistance vs. Gate Voltage

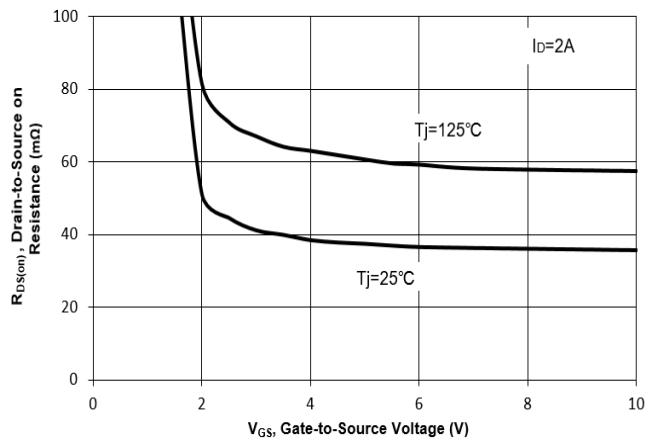


Fig. 5 on-Resistance vs.  $T_j$

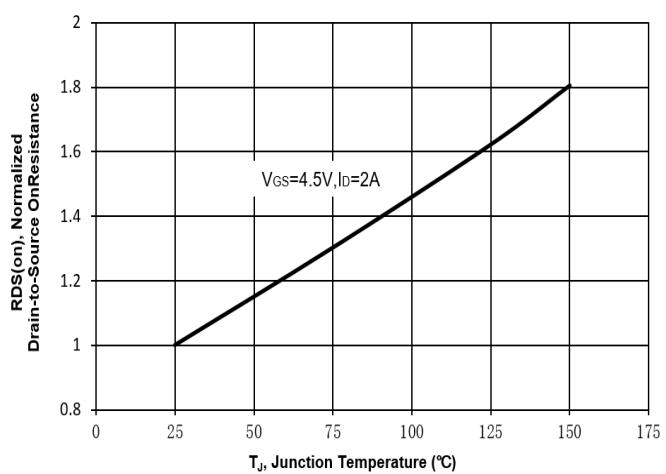
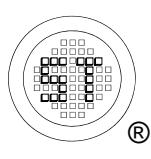
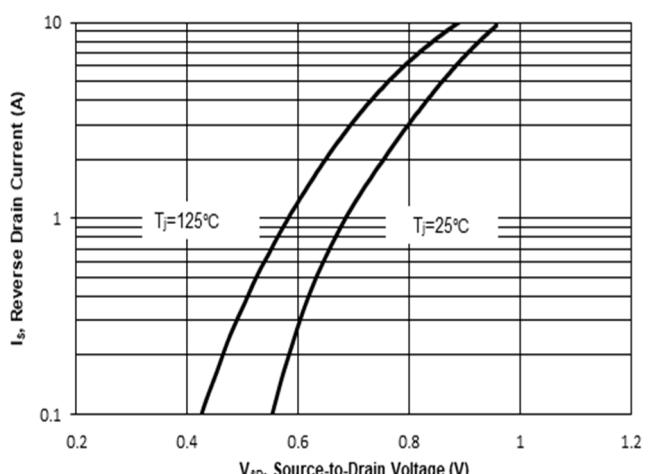


Fig. 6 Typical Forward Characteristic



Preliminary

Dated: 27/04/2021 P1

# MKB03N093LK-HAF

## Electrical Characteristics Curves

Fig. 7 Typical Junction Capacitance

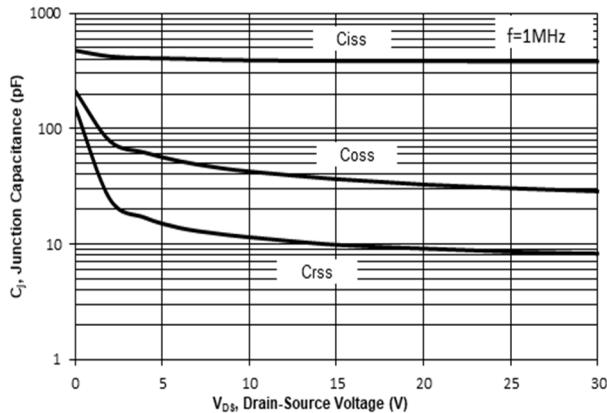


Fig. 8 Drain-Source Leakage Current vs.  $T_j$

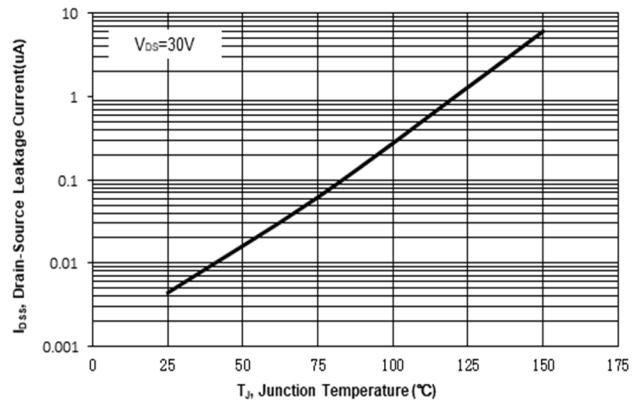


Fig. 9  $V_{(BR)DSS}$  vs. Junction Temperature

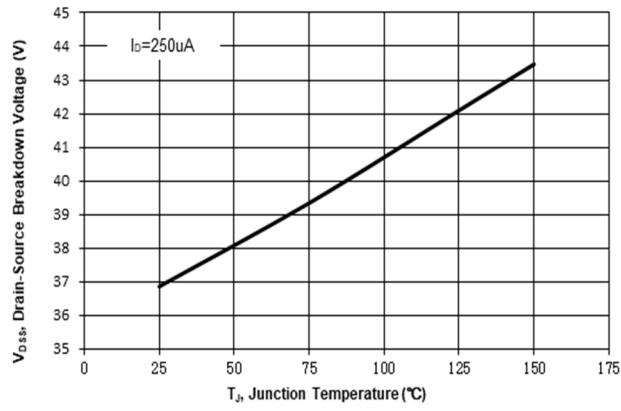


Fig. 10 Gate Threshold Variation vs.  $T_j$

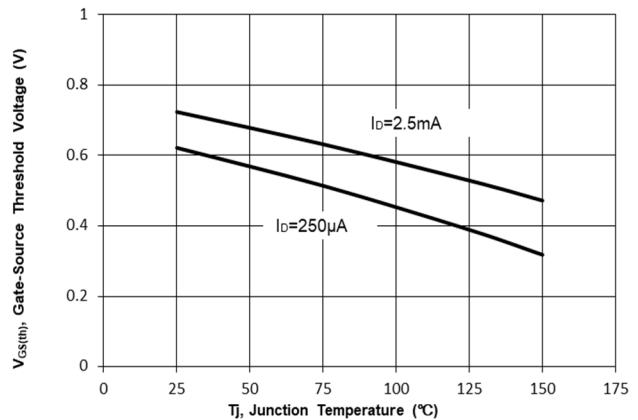
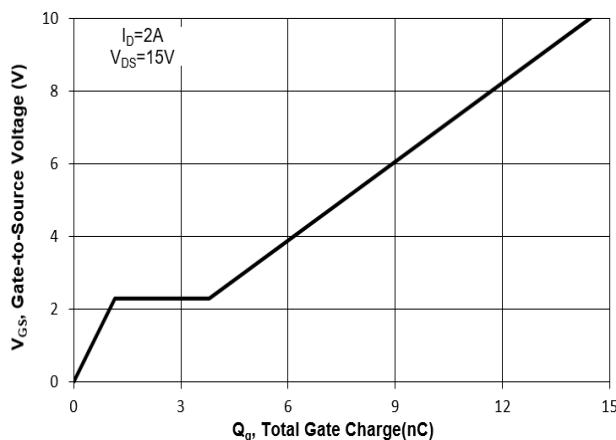


Fig. 11 Gate Charge



# MKB03N093LK-HAF

## Test Circuits

Fig.1-1 Switching times test circuit

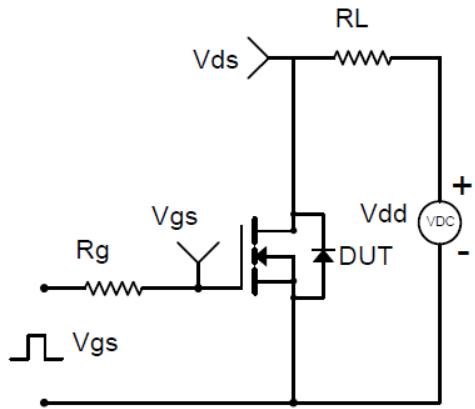


Fig.1-2 Switching Waveform

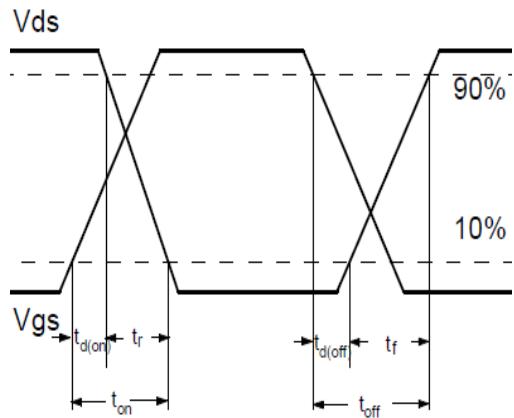


Fig.2-1 Gate charge test circuit

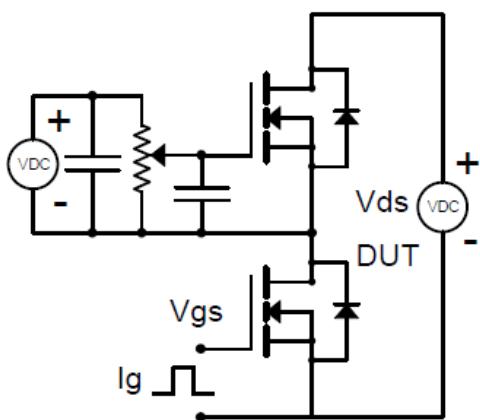
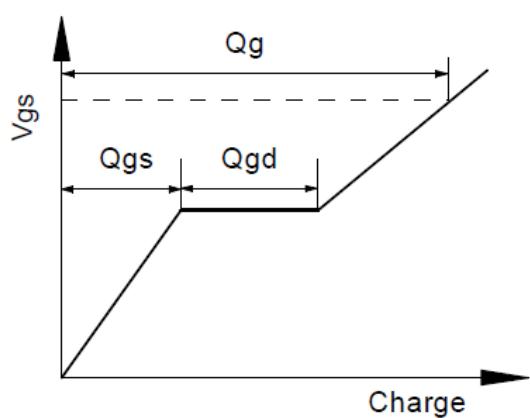


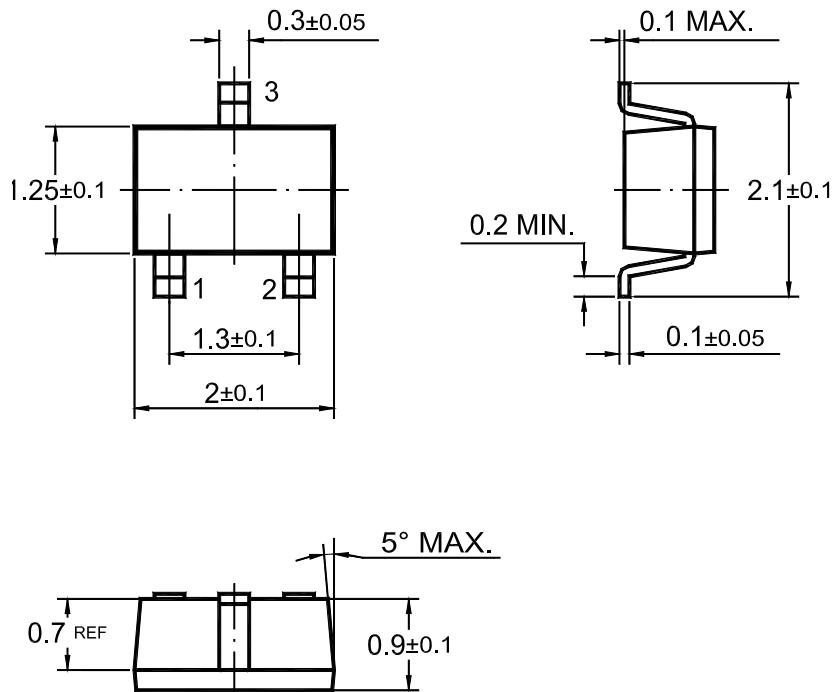
Fig.2-2 Gate charge waveform



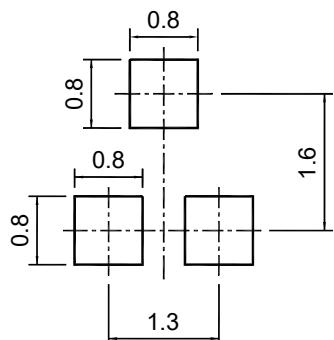
# MKB03N093LK-HAF

## PACKAGE OUTLINE(Dimensions in mm)

SOT-323



## Recommended Soldering Footprint



## Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
SOT-323	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000

## Marking information

"NV" = Part No.

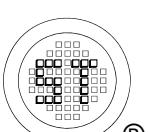
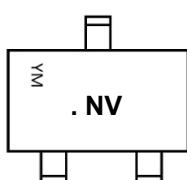
". • ." = HAF (Halogen and Antimony Free)

"YM" = Date Code Marking

"Y" = Year

"M" = Month

Font type: Arial



Preliminary

Dated: 27/04/2021 P1